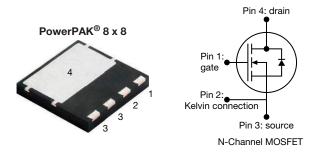
# SiHH186N60EF

Vishay Siliconix

# **EF Series Power MOSFET With Fast Body Diode**



www.vishay.com

PRODUCT SUMMARY					
$V_{DS}$ (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$ 0.168				
Q <sub>g</sub> max. (nC)	32				
Q <sub>gs</sub> (nC)	7				
Q <sub>gd</sub> (nC)	7				
Configuration	Single				

## FEATURES

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and halogen-free	SiHH186N60EF-T1GE3

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V <sub>DS</sub>	600	v
Gate-source voltage			V <sub>GS</sub>	± 30	v
Continuous drain surrent (T 150 °C)	\/t = t 10.\/	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	16	А
Continuous drain current ( $T_J = 150 \ ^\circ C$ )	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		10	
Pulsed drain current <sup>a</sup>	I <sub>DM</sub>	43			
Linear derating factor				0.9	W/°C
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	24	mJ
Maximum power dissipation			PD	114	W
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	100	V/ns
Reverse diode dv/dt c			uv/dt	50	v/ns

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b.  $V_{DD}$  = 120 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 1.3 A
- c.  $I_{SD} \leq I_D, \, di/dt$  = 700 A/µs, starting  $T_J$  = 25  $^\circ C$

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COMPLIANT HALOGEN



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	42	55	°C/W	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	0.76	1.10	C/W	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 250 \mu A$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.69	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	3.0	-	5.0	V
Cata agurag lagkaga		V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 30 V	-	-	± 1	μA
Zara acta valtaga duain avumant		V <sub>DS</sub> =	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	1	μA
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	′, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	2	mA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 9.5 A	-	0.168	0.193	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> =	= 20 V, I <sub>D</sub> = 9.5 A	-	5.4	-	S
Dynamic		<u>.</u>					
Input capacitance	C <sub>iss</sub>		$V_{GS} = 0 V_{V}$	-	1081	-	
Output capacitance	C <sub>oss</sub>	· ·	$V_{\rm DS} = 100  \rm V,$	-	52	-	
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MHz	-	5	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	- V <sub>DS</sub> = 0 V to 480 V, V <sub>GS</sub> = 0 V		-	40	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	247	-	
Total gate charge	Qg			-	21	32	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	$I_D = 9.5 \text{ A}, V_{DS} = 480 \text{ V}$	-	7	-	nC
Gate-drain charge	Q <sub>gd</sub>	1		-	7	-	1
Turn-on delay time	t <sub>d(on)</sub>			-	14	28	
Rise time	t <sub>r</sub>	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 9.5 A,		-	23	46	
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	= 10 V, R <sub>g</sub> = 9.1 $\Omega$	-	25	50	ns
Fall time	t <sub>f</sub>			-	16	32	
Gate input resistance	Rg		f = 1 MHz	0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET sym showing the		-	-	16	
Pulsed diode forward current	I <sub>SM</sub>	p - n junction diode		-	-	43	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 9.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>			-	111	222	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 \ ^{\circ}C, I_F = I_S = 9.5 \ A,$		-	0.6	1.2	μC
Reverse recovery current	I <sub>BBM</sub>	di/dt = 100 A/µs, V <sub>R</sub> = 400 V		-	10	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

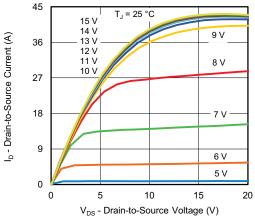


Fig. 1 - Typical Output Characteristics

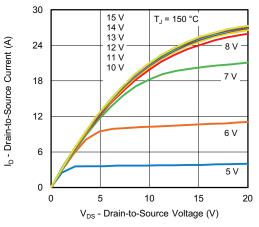


Fig. 2 - Typical Output Characteristics

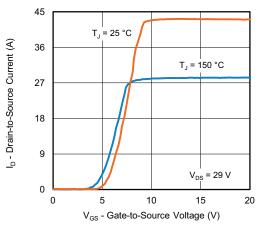


Fig. 3 - Typical Transfer Characteristics

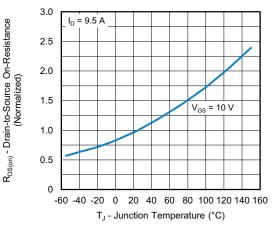


Fig. 4 - Normalized On-Resistance vs. Temperature

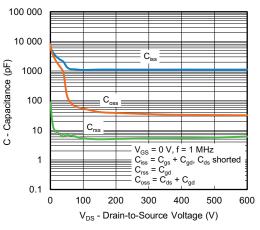
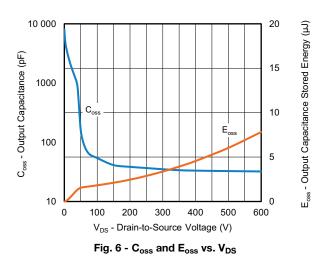


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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**3** For technical questions, contact: <u>hvm@vishay.com</u>

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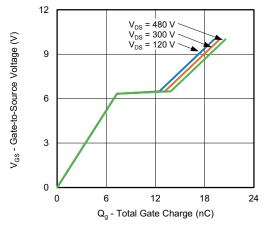


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

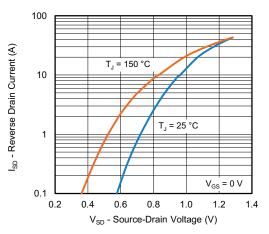


Fig. 8 - Typical Source-Drain Diode Forward Voltage

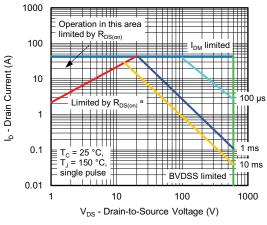


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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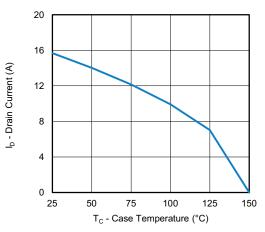


Fig. 10 - Maximum Drain Current vs. Case Temperature

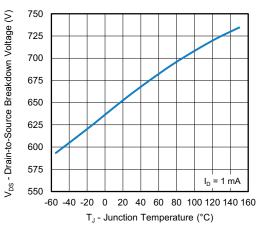
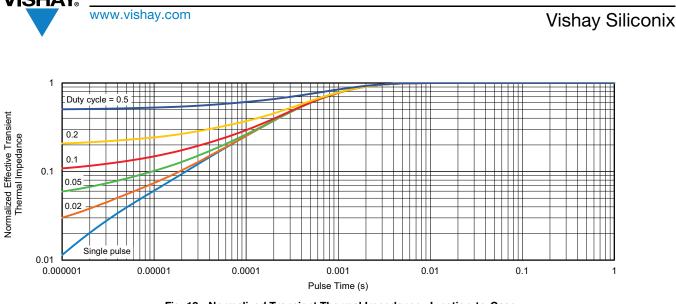
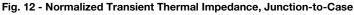


Fig. 11 - Temperature vs. Drain-to-Source Voltage





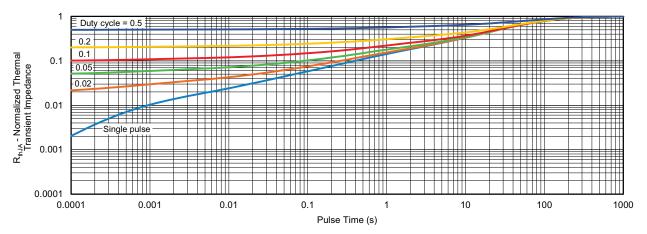


Fig. 13 - Normalized Transient Thermal Impedance, Junction-to-Ambient

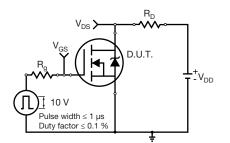


Fig. 14 - Switching Time Test Circuit

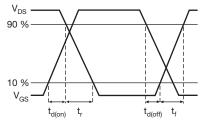


Fig. 15 - Switching Time Waveforms

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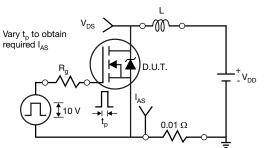


Fig. 16 - Unclamped Inductive Test Circuit

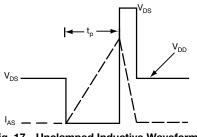


Fig. 17 - Unclamped Inductive Waveforms

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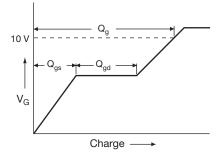


Fig. 18 - Basic Gate Charge Waveform

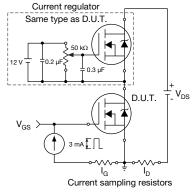
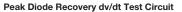


Fig. 19 - Gate Charge Test Circuit



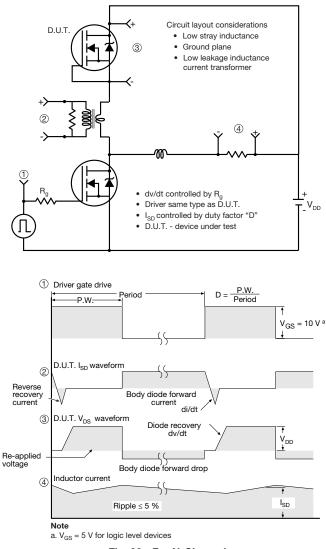


Fig. 20 - For N-Channel

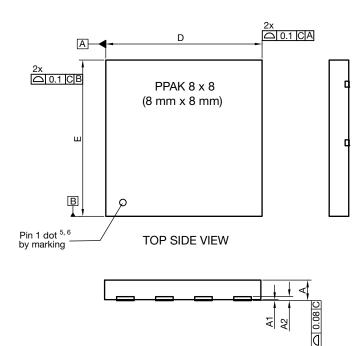
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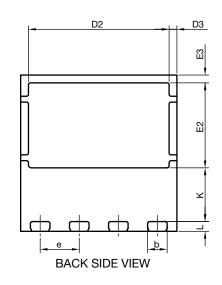
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# PowerPAK<sup>®</sup> 8 x 8 Case Outline





DIM	MILLIMETERS			INCHES				
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.95	1.00	1.05	0.037	0.039	0.041		
A1	0.00	-	0.05	0.000	-	0.002		
A2		020 ref.			0.008 ref.			
b	0.95	1.00	1.05	0.037	0.039	0.041		
D	7.90	8.00	8.10	0.311	0.315	0.319		
D2	7.10	7.20	7.30	0.280	0.283	0.287		
D3	0.40 BSC			0.016 BSC				
е		2.00 BSC		0.079 BSC				
E	7.90	8.00	8.10	0.311	0.315	0.319		
E2	4.30	4.35	4.40	0.169	0.171	0.173		
E3		0.40 BSC			0.016 BSC			
К	2.75 BSC		0.108 BSC					
L	0.45	0.50	0.55	0.018	0.020	0.022		
N <sup>(3)</sup>	8				8			

### Notes

<sup>(1)</sup> Use millimeters as the primary measurement

<sup>(2)</sup> Dimensioning and tolerances conform to ASME Y14.5 M - 1994

<sup>(3)</sup> N is the number of terminals

<sup>(4)</sup> The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

<sup>(5)</sup> Exact shape and size of this feature is optional

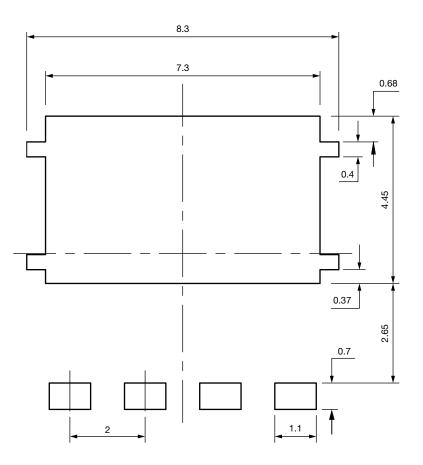
ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

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# Recommended Minimum PADs for PowerPAK<sup>®</sup> 8 mm x 8 mm



**Dimensions in millimeters** 



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